



Surface Mount Fast Recovery Rectifiers
Reverse Voltage 50 to 1000 Volts Forward Current 3.0 Amperes

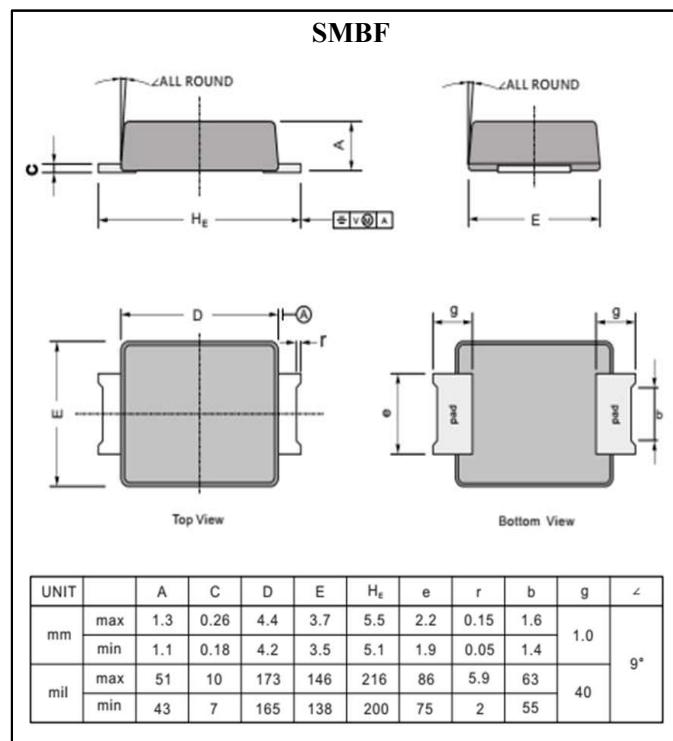
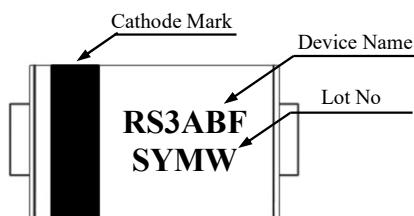
Features

- For surface mounted application
- Glass passivated junction chip
- Fast reverse recovery time
- Fast switching for high efficiency
- High current capability
- High temperature soldering: 260°C/10 seconds at terminals

Mechanical Data

- Case : Molded plastic
- Terminals : Solderable plated
- Polarity : Indicated by cathode band
- Weight : 0.21 grams

Marking



Maximum Ratings & Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified

Single phase half wave 60 HZ, resistive or inductive load

For capacitive load, derate current by 20%

Parameter	Symbol	RS3A BF	RS3B BF	RS3D BF	RS3G BF	RS3J BF	RS3K BF	RS3M BF	Unit	Remark
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V	
Maximum Average Forward Rectified Current	I _{F(AV)}								A	
Peak Forward Surge Current 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}								A	
Maximum Instantaneous Forward Voltage @ 3.0A	V _F								V	
Maximum DC Reverse Current at Rated DC Blocking Voltage	I _R								uA	T _a =25°C
									uA	T _a =125°C
Maximum Reverse Recovery Time	trr				150		250	500	ns	Note 1
Typical Junction Capacitance	C _J					60			pF	Note 2
Typical Thermal Resistance	R _{th(j-a)}					50			°C/W	Note 3
						15			°C/W	
Operation Junction and Storage Temperature Range	T _J , T _{STG}					-55 to +150			°C	

Note 1. Reverse Recovery Time Test Conditions : I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 2. Measured at 1MHz and Applied Reverse Voltage of 4.0Volts D.C.

Note 3. Measured on P.C.Board with 0.6" × 0.6" (16mm×16mm) Copper Pad Areas.



Ratings and Characteristics Curves (Ta=25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

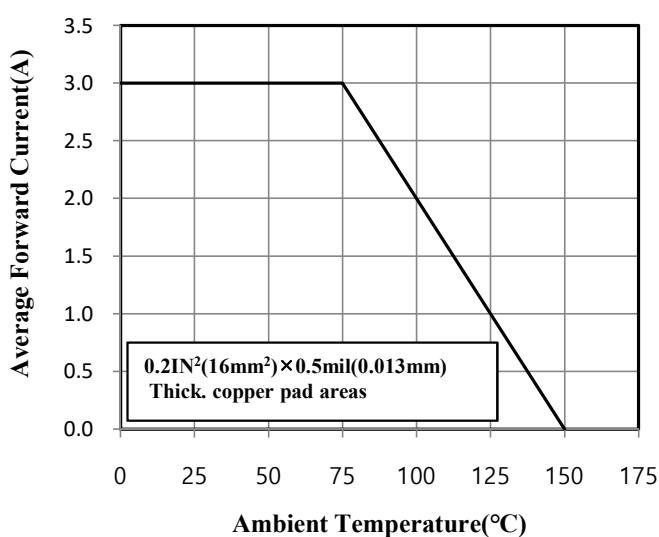


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

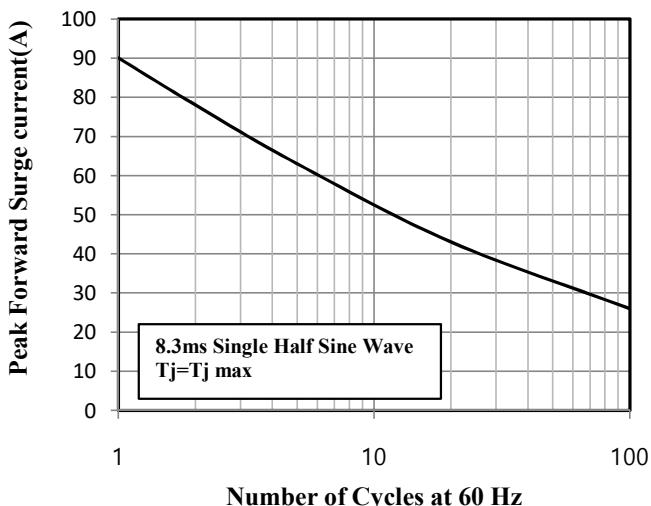


Fig.3 Typical Instantaneous Forward Characteristics

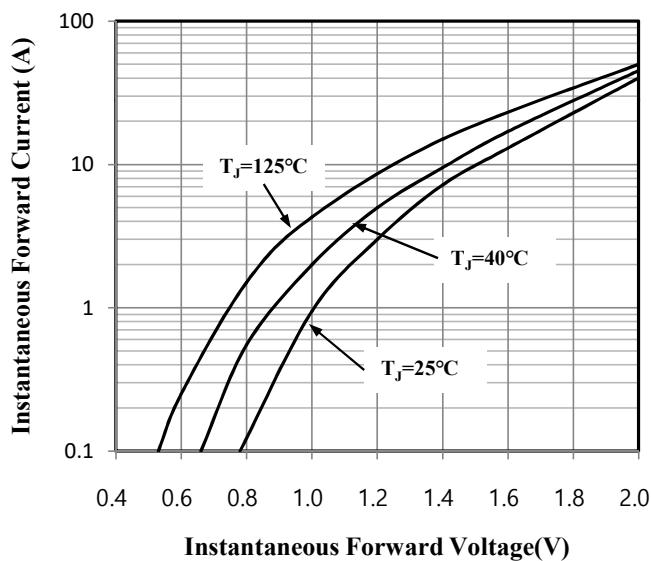


Fig.4 Typical Junction Capacitance

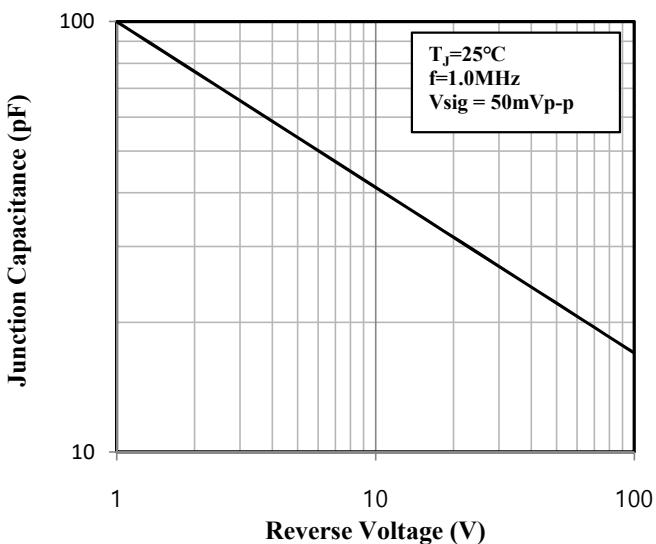


Fig.5 Typical Reverse Characteristics

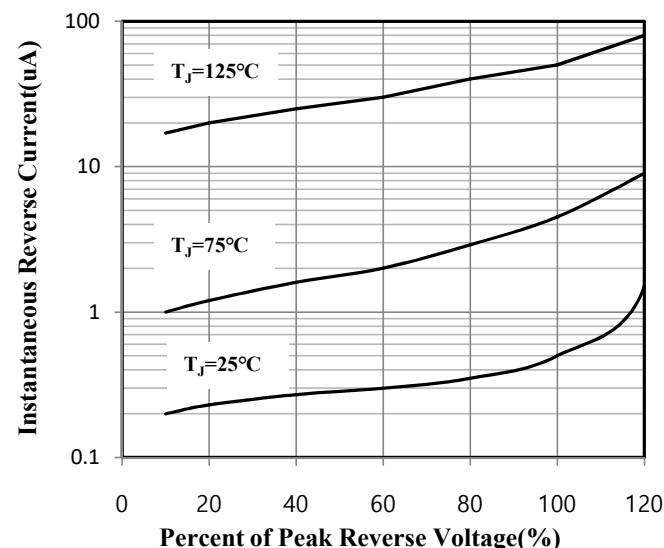


Fig.6 Reverse Recovery Time Charateristic and Test Circuit Diagram

